

General Description

This Trench MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for Back-light Inverter and Power Supply.

FEATURES

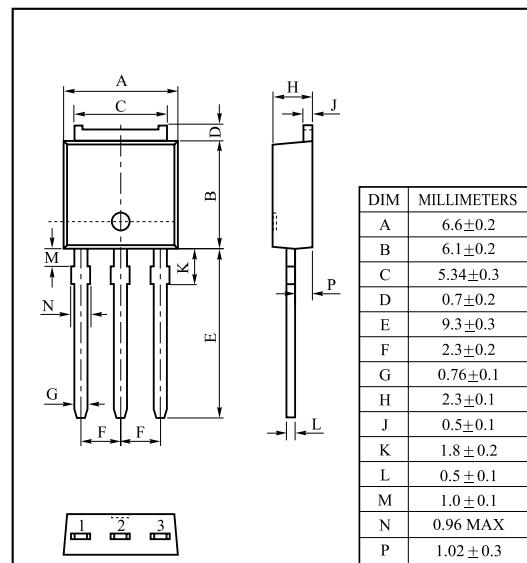
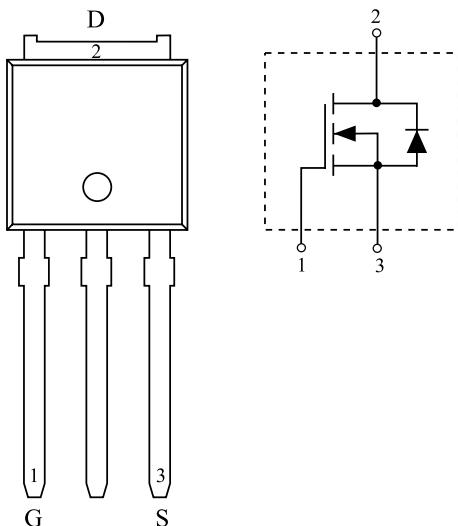
- $V_{DSS}=40V$, $I_D=54A$.
- Low Drain-Source ON Resistance.
 - : $R_{DS(ON)}=8.5m\Omega$ (Max.) @ $V_{GS}=10V$
 - : $R_{DS(ON)}=11m\Omega$ (Max.) @ $V_{GS}=4.5V$
- Super High Dense Cell Design.
- High Power and Current Handling Capability.

MAXIMUM RATING (Ta=25 Unless otherwise Noted)

CHARACTERISTIC	SYMBOL	N-Ch	UNIT
Drain-Source Voltage	V_{DSS}	40	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current	I_D @ $T_C=25$ (Note1)	I_D	A
	Pulsed (Note2)	I_{DP}	
Drain-Source-Diode Forward Current	I_S	100	A
Drain Power Dissipation	P_D @ $T_C=25$ (Note1)	45	W
	@ $T_a=25$ (Note2)	3.1	
Maximum Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 ~ 150	
Thermal Resistance, Junction to Case (Note1)	R_{thJC}	2.8	/W
Thermal Resistance, Junction to Ambient (Note2)	R_{thJA}	40	/W

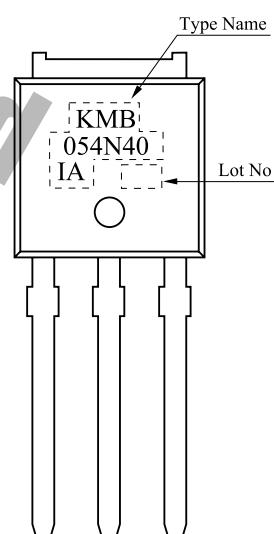
Note 1) R_{thJC} means that the infinite heat sink is mounted.

Note 2) Surface Mounted on 1 x 1 Pad of 2 oz copper.

PIN CONNECTION (TOP VIEW)

IPAK(1)

Marking



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ELECTRICAL CHARACTERISTICS (Ta=25 °C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250 μA	40	-	-	V
Drain Cut-off Current	I _{DSS}	V _{GS} =0V, V _{DS} =32V	-	-	1	μA
Gate Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{th}	V _{DS} =V _{GS} , I _D =250 μA	1	1.9	3	V
Drain-Source ON Resistance	R _{DS(ON)*}	V _{GS} =10V, I _D =14A	-	6.5	8.5	m
		V _{GS} =4.5V, I _D =11A	-	8.5	11	
		V _{GS} =10V, I _D =14A, T _j =125	-	10.4	14	
Forward Transconductance	g _{f*}	V _{DS} =10V, I _D =20A	-	58	-	S
Dynamic						
Input Capacitance	C _{iss}	V _{DS} =20V, f=1MHz, V _{GS} =0V	-	1280	-	pF
Output Capacitance	C _{oss}		-	250	-	
Reverse Transfer Capacitance	C _{rss}		-	125	-	
Total Gate Charge	V _{GS} =10V	V _{DS} =20V, V _{GS} =10V, I _D =14A	-	25.4	-	nC
	V _{GS} =5V		-	13.8	-	
Gate-Source Charge	Q _{gs*}		-	5.7	-	
Gate-Drain Charge	Q _{gd*}		-	5.4	-	
Turn-On Delay Time	t _{d(on)*}	V _{DD} =20V, V _{GS} =10V I _D =1A, R _G =6	-	19	-	ns
Turn-On Rise Time	t _{r*}		-	16	-	
Turn-Off Delay Time	t _{d(off)*}		-	60	-	
Turn-Off Fall Time	t _{f*}		-	14	-	
Source-Drain Diode Ratings						
Source-Drain Forward Voltage	V _{SDF*}	V _{GS} =0V, I _S =14A	-	0.8	1.2	V
Note>* Pulse Test : Pulse width <300μs , Duty cycle < 2%						

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Fig1. I_D - V_{DS}

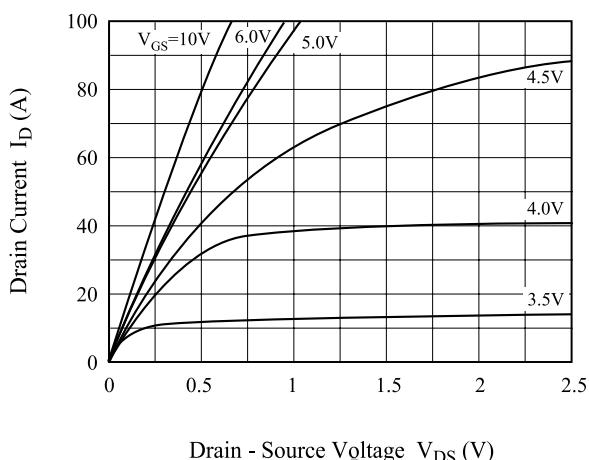


Fig2. $R_{DS(ON)}$ - I_D

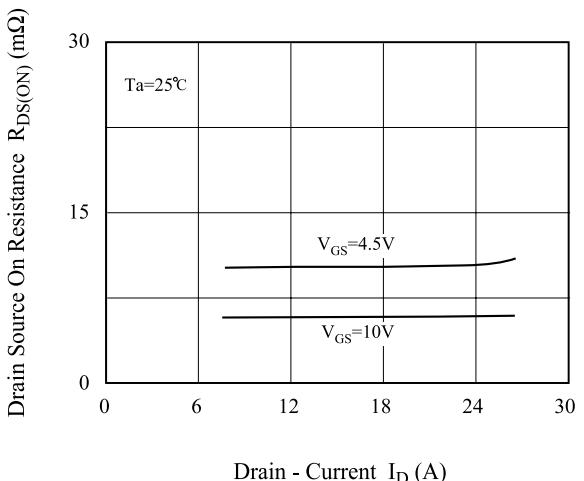


Fig3. I_D - V_{GS}

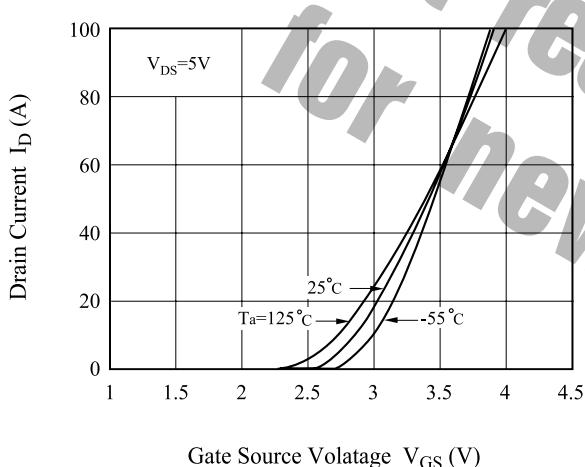


Fig4. $R_{DS(on)}$ - T_j

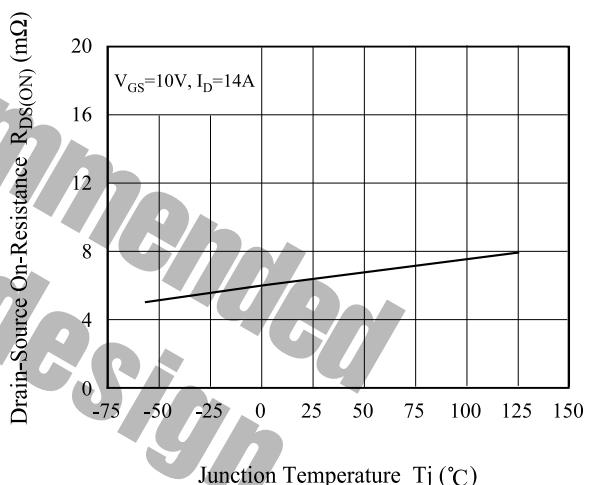


Fig5. V_{th} - T_j

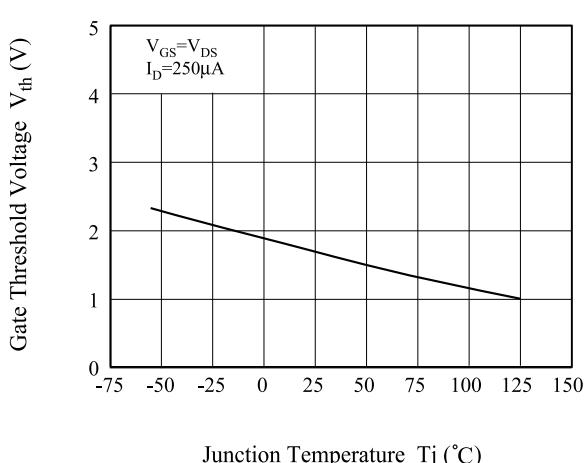
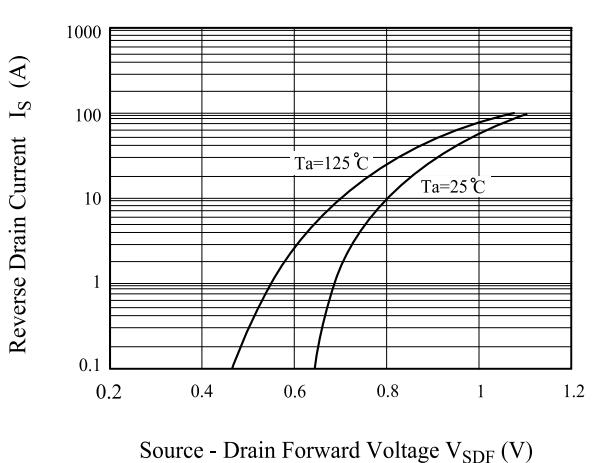


Fig6. I_S - V_{SDF}



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Fig 7. V_{GS} - Q_g

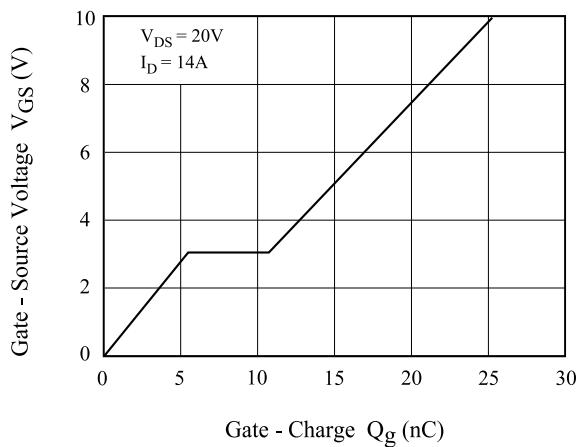


Fig 8. C - V_{DS}

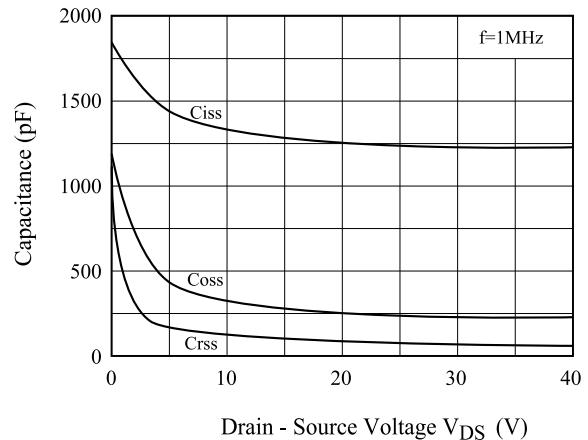


Fig9. Safe Operation Area

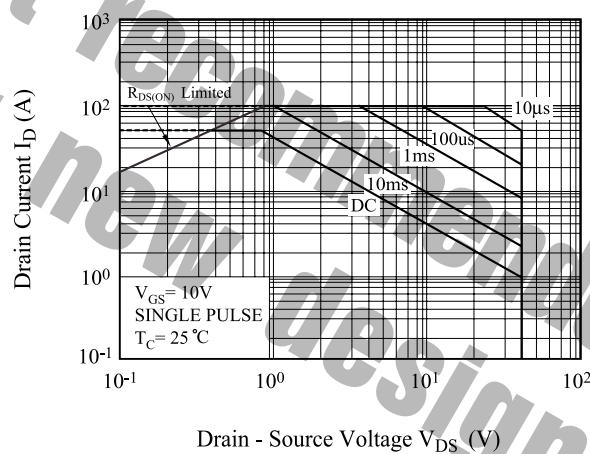
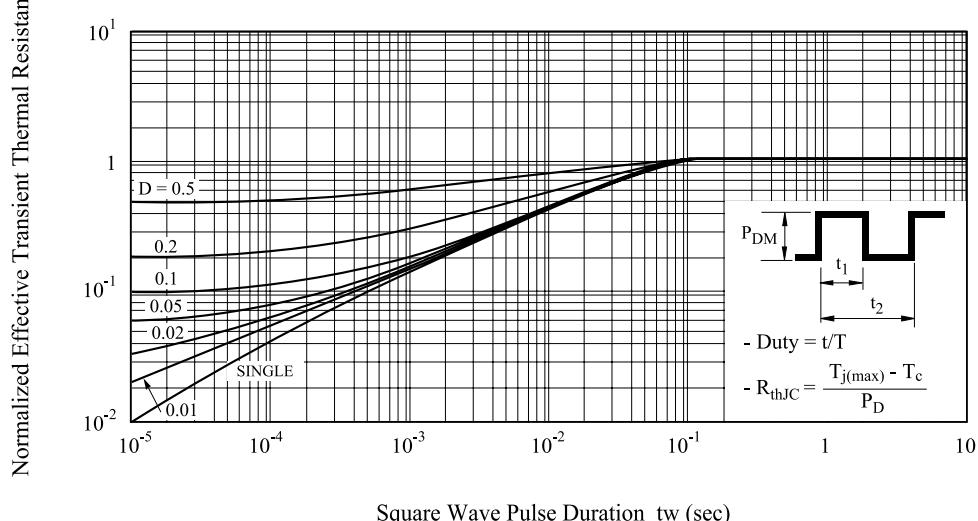


Fig10. Transient Thermal Response Curve



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Fig11. Gate Charge Circuit and Wave Form

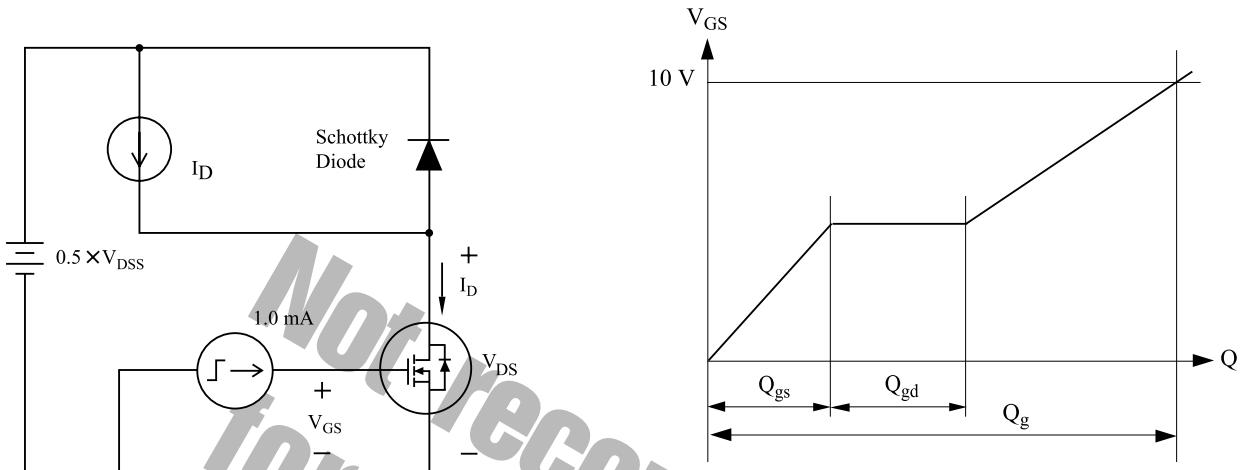


Fig12. Resistive Load Switching

